4V Drive Pch MOSFET **RSU002P03**

Structure

Silicon P-channel MOSFET

● Features

- 1) Low On-resistance
- 2) 4V drive

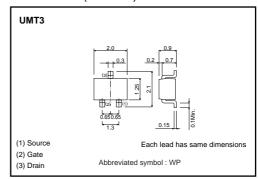
Applications

Switching

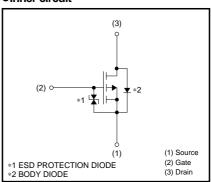
Packaging specifications

	Package	Taping	
Type	Code	T106	
	Basic ordering unit (pieces)	3000	
RSU002P03		0	

●Dimensions (Unit:mm)



•Inner circuit



● Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		VDSS	-30	V
Gate-source voltage		V _{GSS}	±20	V
Drain current	Continuous	ID	±0.25	Α
	Pulsed	I _{DP} *1	±0.5	А
Total power dissipation		P _D *2	0.2	W
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg	-55 to +150	°C

Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth(ch-a)*	625	°C/W

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^{*1} Pw≤10µs, Duty cycle≤1% *2 Each terminal mounted on a recommended land

^{*} Each terminal mounted on a recommended land

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	-	±10	μΑ	Vgs=±20V, Vps=0V
Drain-source breakdown voltage	V(BR) DSS	-30	_	_	٧	ID= -1mA, VGS=0V
Zero gate voltage drain current	IDSS	_	_	-1	μΑ	Vps= -30V, Vgs=0V
Gate threshold voltage	V _{GS (th)}	-1.0	_	-2.5	٧	$V_{DS} = -10V, I_{D} = -1mA$
Static drain-source on-state resistance	R _{DS} (on)*	-	0.9	1.4	Ω	I _D = -0.25A, V _G s= -10V
		_	1.4	2.1	Ω	I _D = -0.15A, V _G s= -4.5V
		_	1.6	2.4	Ω	I _D = -0.15A, V _G s= -4V
Forward transfer admittance	Y _{fs} *	0.2	-	_	S	V _{DS} = -10V, I _D = -0.15A
Input capacitance	Ciss	-	30	_	pF	V _{DS} = -10V
Output capacitance	Coss	-	4	_	pF	V _{GS} =0V
Reverse transfer capacitance	Crss	-	5	_	pF	f=1MHz
Turn-on delay time	t _{d (on)} *	-	8	_	ns	Vpp≒ –15V
Rise time	tr *	-	5	_	ns	ID= -0.15A
Turn-off delay time	t _{d (off)} *	-	30	_	ns	Vgs= -10V Rι=100Ω
Fall time	t _f *	-	40	_	ns	R _G =10Ω

*Pulsed

●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp	_	-	-1.2	V	I _S = -0.1A, V _{GS} =0V

•Electrical characteristics curves

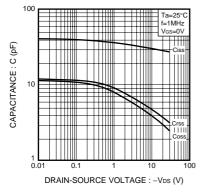


Fig.1 Typical Capacitance vs. Drain-Source Voltage

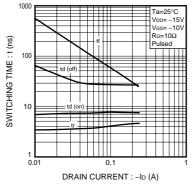


Fig.2 Switching Characteristics

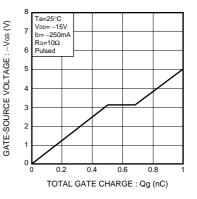


Fig.3 Dynamic Input Characteristics

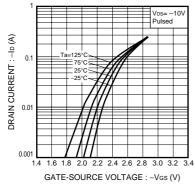


Fig.4 Typical Transfer Characteristics

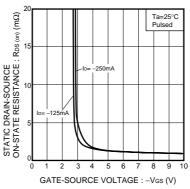


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

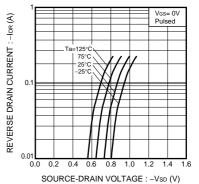


Fig.6 Reverse Drain Current vs. Source-Drain Voltage

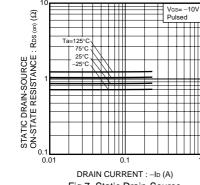
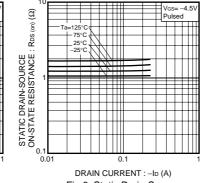
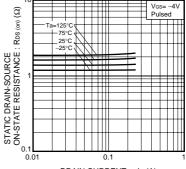


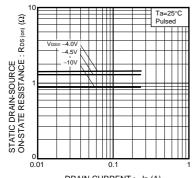
Fig.7 Static Drain-Source
On-State Resistance vs.
Drain current (I)



DRAIN CURRENT : -I_D (A)
Fig.8 Static Drain-Source
On-State Resistance vs.
Drain current (II)



DRAIN CURRENT : -ID (A)
Fig.9 Static Drain-Source
On-State Resistance vs.
Drain current (III)



DRAIN CURRENT: -Io (A)
Fig.10 Static Drain-Source
On-State Resistance vs.
Drain current (IV)

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Appendix1-Rev1.1

